

# Electrifi Conductive Filament

## Recommended Printing Parameters (FFF/FDM)

*Electrifi is a soft, highly conductive copper–polymer composite. These parameters are intended to maximize print reliability and electrical performance rather than print speed.*

---

### 1. Printer & Hardware Configuration (Critical)

- **Extruder type:**
  - **Direct-drive extruder strongly recommended**
  - Bowden-style extruders not recommended
  - AMS / multi-material feed systems not compatible
- **Filament path:**
  - Short, straight, and well-constrained
  - Avoid sharp bends, long guide tubes, or excessive drag
- **Nozzle:**
  - Brass or hardened steel
  - **Minimum diameter:** 0.4 mm
  - **Preferred diameter:** 0.6 mm or larger for improved reliability

---

### 2. Temperature Settings

Parameter	Recommended Range
Nozzle temperature	<b>140–180 °C</b>
Bed temperature	<b>≤ 50 °C</b>
Chamber temperature	Ambient (enclosure not required)

#### Notes:

- Avoid extended dwell time at nozzle temperature to reduce heat creep
- Where possible, lower standby nozzle temperatures in start G-code

---

### 3. Print Speed & Motion

Parameter	Recommended Value
-----------	-------------------

Parameter	Recommended Value
Print speed	<b>10–30 mm/s</b>
First-layer speed	<b>5–15 mm/s</b>
Travel speed	Moderate
Acceleration	Low to moderate

*Lower speeds reduce compressive buckling and improve dimensional and electrical consistency.*

---

## 4. Retraction & Extrusion Control

Parameter	Recommendation
Retraction	<b>Minimize or disable</b>
Retraction distance	$\leq 0.5$ mm (if required)
Retraction speed	Slow
Coasting / wipe	Use cautiously

*Excessive retraction is a common cause of jams when printing soft conductive filaments.*

---

## 5. Layer & Geometry Settings

Parameter	Recommended Range
Layer height	<b>0.2–0.3 mm</b>
Line width	$\geq$ nozzle diameter (preferably +10–20%)
Wall count	$\geq 2$ perimeters
Infill	100% for conductive features

### Electrical performance improves with:

- Increased trace width and thickness
- Shorter conductor lengths
- Fewer inter-layer interfaces

---

## 6. Cooling

- **Part cooling fan:**
  - Low to moderate (0–40%)
  - Avoid aggressive cooling during extrusion

- **Hotend cooling:**
  - Strong, continuous heat-break cooling is essential

---

## 7. Material Handling

- Electrifi is **soft and flexible**
- Avoid tight spool holders or high filament tension
- Ensure smooth feeding with minimal drag
- Drying is typically not required, but filament should be kept clean and dry

---

## 8. Recommended Applications

- Single-material conductive prints
- Embedded conductors and traces
- Conductive sockets and contact features
- Heaters, antennas, and EMI structures

### Not recommended:

- High-speed printing profiles
- Automatic material switching systems
- Long Bowden-fed setups

---

## 9. Practical Note

Electrifi performs best when treated as a **conductive structural material**, not a solder replacement. Electrical performance is strongly influenced by **geometry, contact pressure, and interface design**, not just bulk conductivity.

---

For application notes, troubleshooting guidance, or printer-specific profiles, please contact Multi3D, Inc.